PSMN2R0-30PL



N-channel 30 V 2.1 m Ω logic level MOSFET

Rev. 01 — 24 June 2009

Product data sheet

1. Product profile

1.1 General description

Logic level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- Suitable for logic level gate drive sources

1.3 Applications

- DC-to-DC converters
- Load switiching

- Motor control
- Server power supplies

1.4 Quick reference data

Table 1. Quick reference

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DS}	drain-source voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}$		-	-	30	V
I _D	drain current	T_{mb} = 25 °C; V_{GS} = 10 V; see <u>Figure 1</u>	[1]	-	-	100	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	-	211	W
Dynamic	characteristics						
Q_{GD}	gate-drain charge	$V_{GS} = 4.5 \text{ V}; I_D = 25 \text{ A};$		-	16	-	nC
Q _{G(tot)}	total gate charge	$V_{DS} = 12 \text{ V}$; see <u>Figure 13</u> ; see <u>Figure 14</u>		-	55	-	nC
Static ch	aracteristics						
R_{DSon}	drain-source on-state resistance	$V_{GS} = 4.5 \text{ V}; I_D = 15 \text{ A};$ $T_j = 25 \text{ °C}$		-	2	2.8	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 15 \text{ A};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 12}{}$	[2]	-	1.7	2.1	mΩ

^[1] Continuous current is limited by package.



^[2] Measured 3 mm from package.

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Pinning information

Table 2. **Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	D	drain	mb	D
3	S	source		$G \longrightarrow \overline{A}$
mb	D	mounting base; connected to drain	1 2 3	mbb076 S
			SOT78 (TO-220AB)	

Ordering information 3.

Table 3. **Ordering information**

Product data sheet

Type number	Package				
	Name	Description	Version		
PSMN2R0-30PL	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78		

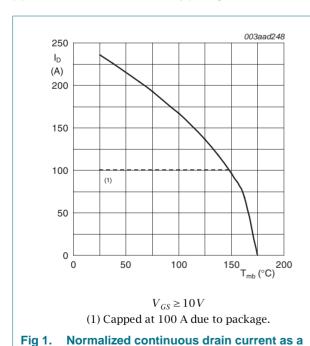
Limiting values

Table 4. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Darameter	Conditions		Min	Max	Unit
Symbol	Parameter			IVIIII	IVIAX	Unit
V_{DS}	drain-source voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}$		-	30	V
V_{DGR}	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$		-	30	V
V_{GS}	gate-source voltage			-20	20	V
I _D	drain current	$V_{GS} = 10 \text{ V}; T_{mb} = 100 \text{ °C}; \text{ see } \frac{\text{Figure 1}}{\text{Model}}$	[1]	-	100	Α
		V _{GS} = 10 V; T _{mb} = 25 °C; see <u>Figure 1</u>	[1]	-	100	Α
I_{DM}	peak drain current	t _p ≤ 10 μs; pulsed; T _{mb} = 25 °C; see <u>Figure 3</u>		-	943	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	211	W
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-dra	ain diode					
Is	source current	T _{mb} = 25 °C	[1]	-	100	Α
I _{SM}	peak source current	t _p ≤ 10 μs; pulsed; T _{mb} = 25 °C		-	943	Α
Avalanche	ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 100 A; V_{sup} ≤ 30 V; R_{GS} = 50 Ω; unclamped		-	555	mJ

[1] Continuous current is limited by package.

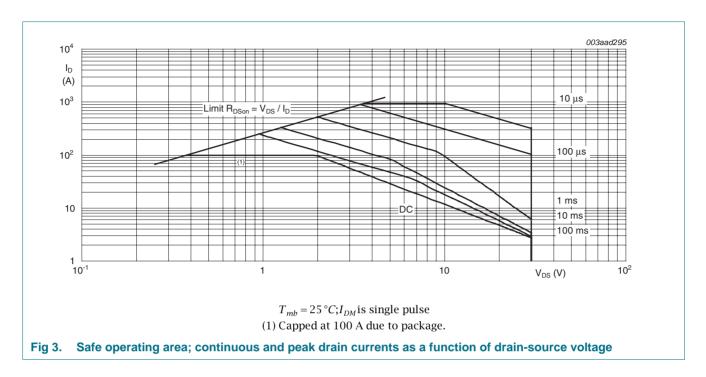


function of mounting base temperature

03aa16 120 P_{der} (%) 80 40 150 200 T_{mb} (°C) $P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$

Normalized total power dissipation as a Fig 2. function of mounting base temperature

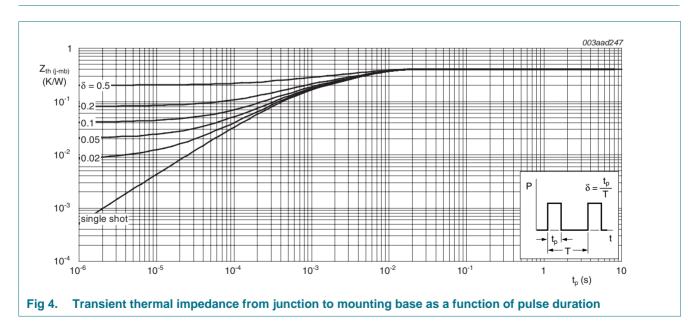
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5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 4	-	0.41	0.71	K/W



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6. Characteristics

Table 6. Characteristics

Table 6.	Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	racteristics						
V _{(BR)DSS} drain-source		$I_D = 250 \mu A; V_{GS} = 0 V; T_j = 25 °C$		30	-	-	V
	breakdown voltage	$I_D = 250 \mu A; V_{GS} = 0 V; T_j = -55 °C$		27	-	-	V
$V_{GS(th)}$	V _{GS(th)} gate-source threshold voltage	$I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = 25$ °C; see <u>Figure 9</u> ; see <u>Figure 10</u>		1.3	1.7	2.15	V
		$I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = 175$ °C; see Figure 10		0.5	-	-	V
		I_D = 1 mA; V_{DS} = V_{GS} ; T_j = -55 °C; see <u>Figure 10</u>		-	-	2.45	V
I _{DSS}	drain leakage current	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	3	μΑ
	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$			-	-	70	μΑ
I _{GSS}	gate leakage current	$V_{GS} = 16 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nΑ
		$V_{GS} = -16 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nΑ
R _{DSon}	drain-source on-state	$V_{GS} = 4.5 \text{ V}; I_D = 15 \text{ A}; T_j = 25 \text{ °C}$		-	2	2.8	mΩ
resistance	$V_{GS} = 10 \text{ V}; I_D = 15 \text{ A}; T_j = 100 ^{\circ}\text{C};$ see Figure 11		-	-	3	mΩ	
		$V_{GS} = 10 \text{ V}; I_D = 15 \text{ A}; T_j = 25 ^{\circ}\text{C};$ see Figure 12	[2]	-	1.7	2.1	mΩ
R _G	gate resistance	f = 1 MHz		-	0.78	-	Ω
Dynamic	characteristics						
Q _{G(tot)}	total gate charge	I_D = 25 A; V_{DS} = 12 V; V_{GS} = 10 V; see <u>Figure 13</u> ; see <u>Figure 14</u>		-	117	-	nC
		I_D = 25 A; V_{DS} = 12 V; V_{GS} = 4.5 V; see <u>Figure 13</u> ; see <u>Figure 14</u>		-	55	-	nC
Q _{GS}	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 4.5 \text{ V};$		-	17	-	nC
Q _{GS(th)}	pre-threshold gate-source charge	see <u>Figure 13</u> ; see <u>Figure 14</u>		-	11	-	nC
Q _{GS(th-pl)}	post-threshold gate-source charge			-	6	-	nC
Q_{GD}	gate-drain charge			-	16	-	nC
$V_{GS(pl)}$	gate-source plateau voltage	V _{DS} = 12 V; see <u>Figure 13</u> ; see <u>Figure 14</u>		-	2.6	-	V
C _{iss}	input capacitance	$V_{DS} = 12 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$		-	6810	-	pF
C _{oss}	output capacitance	$T_j = 25 ^{\circ}\text{C}$; see Figure 15		-	1410	-	pF
C _{rss}	reverse transfer capacitance			-	650	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 12 V; R_{L} = 0.5 Ω ; V_{GS} = 4.5 V;		-	63	-	ns
t _r	rise time	$R_{G(ext)} = 4.7 \Omega$		-	125	-	ns
t _{d(off)}	turn-off delay time			-	111	-	ns
t _f	fall time			-	59	-	ns

Table 6. Characteristics ... continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Source-dr	ain diode					
V_{SD}	source-drain voltage	$I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C};$ see <u>Figure 16</u>	-	0.76	1.2	V
t _{rr}	reverse recovery time	$I_S = 20 \text{ A}; \text{ d}I_S/\text{d}t = -100 \text{ A/}\mu\text{s}; V_{GS} = 0 \text{ V};$	-	49	-	ns
Qr	recovered charge	$V_{DS} = 30 \text{ V}$	-	66	-	nC

- [1] Tested to JEDEC standards where applicable.
- [2] Measured 3 mm from package.

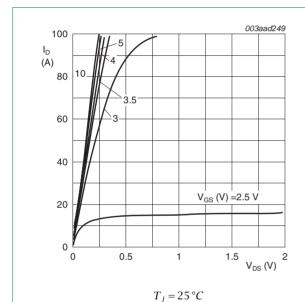


Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values

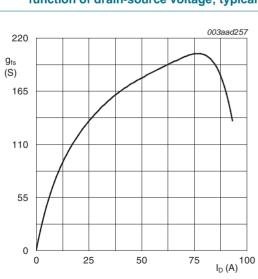


Fig 7. Forward transconductance as a function of drain current; typical values

 $T_i = 25 \,^{\circ}C; V_{DS} = 25 \,^{\circ}V$

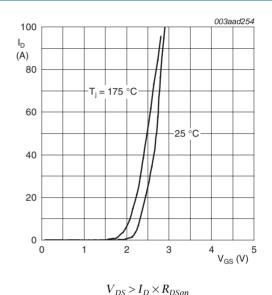


Fig 6. Transfer characteristics: drain current as a function of gate-source voltage; typical values

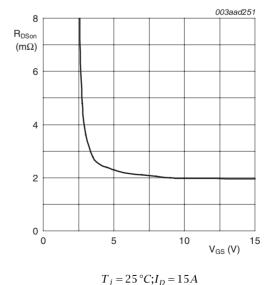
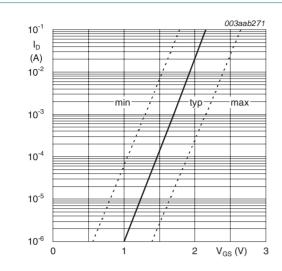


Fig 8. Drain source on-state resistance as a function of gate-source voltage; typical values

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 $T_{j} = 25 \,^{\circ}C; V_{DS} = 5 \, V$

Fig 9. Sub-threshold drain current as a function of gate-source voltage

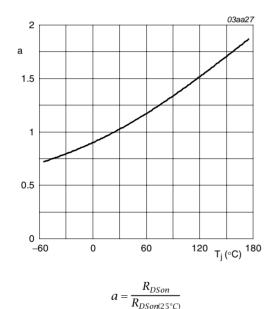
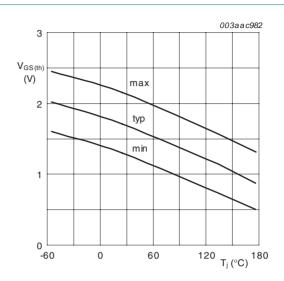


Fig 11. Normalized drain-source on-state resistance factor as a function of junction temperature



 $I_D = 1 \, mA; V_{DS} = V_{GS}$

Fig 10. Gate-source threshold voltage as a function of junction temperature

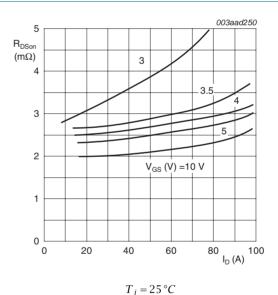


Fig 12. Drain-source on-state resistance as a function of drain current; typical values

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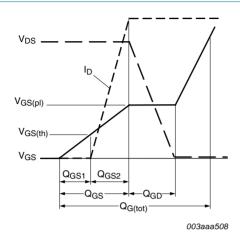
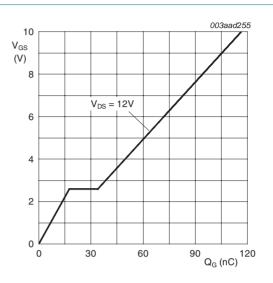


Fig 13. Gate charge waveform definitions



$$T_j = 25 \,{}^{\circ}C; I_D = 25A$$

Fig 14. Gate-source voltage as a function of gate charge; typical values

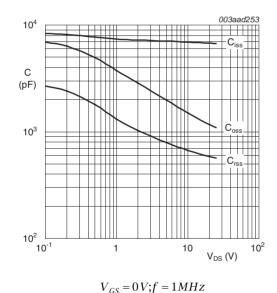


Fig 15. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

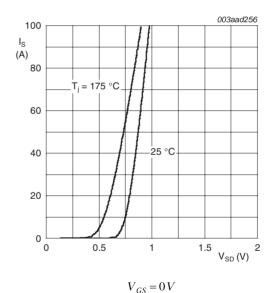


Fig 16. Source current as a function of source-drain voltage; typical values

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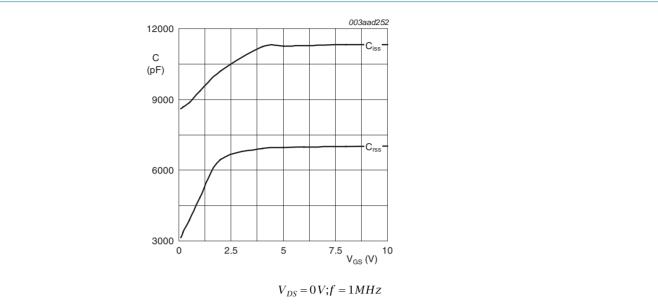
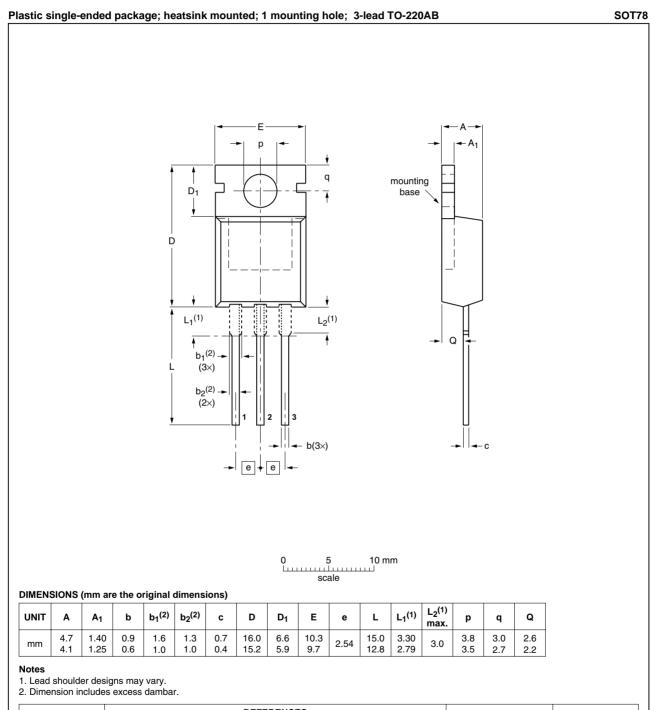


Fig 17. Input and reverse transfer capacitances as a function of gate-source voltage; typical values

7. Package outline



OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT78		3-lead TO-220AB	SC-46		08-04-23 08-06-13	

Fig 18. Package outline SOT78 (TO-220AB)

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8. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN2R0-30PL_1	20090624	Product data sheet	-	-

N-channel 30 V 2.1 mΩ logic level MOSFET

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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